

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	198043	((silicon semiconductor) adj2 (wafer backplane) microdisplay)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:11
L2	428	seal\$3 with lithographic\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:40
L3	42	1 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:25
L4	125	(lithographic\$5 adj2 (form\$2 process)) same seal\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:20
L5	30	1 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:25
L6	633	349/153	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:28
L7	3	6 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:32
L8	278	349/190	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:28
L9	3	8 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:29
L10	4	8 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:39
L11	2	6 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:32
L12	46	seal\$3 adj4 lithographic\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:34
L13	6	1 and 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:33

L14	125	349/93	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:40
L15	0	2 and 14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:40
L16	8912	lithographic\$5 adj process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:41
L17	3393	1 and 16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:40
L18	11	seal\$3 with lithographic\$5 adj process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/04/03 17:41